

R1LV0108E Series

1Mb Advanced LPSRAM (128k word x 8bit)

R10DS0271EJ0100 Rev.1.00 2017.1.27

Description

The R1LV0108E Series is a family of low voltage 1-Mbit static RAMs organized as 131,072-word by 8-bit, fabricated by Renesas's high-performance 0.15um CMOS and TFT technologies. The R1LV0108E Series has realized higher density, higher performance and low power consumption. The R1LV0108E Series is suitable for memory applications where a simple interfacing, battery operating and battery backup are the important design objectives. It has been packaged in 32-pin SOP, 32-pin TSOP and 32-pin sTSOP.

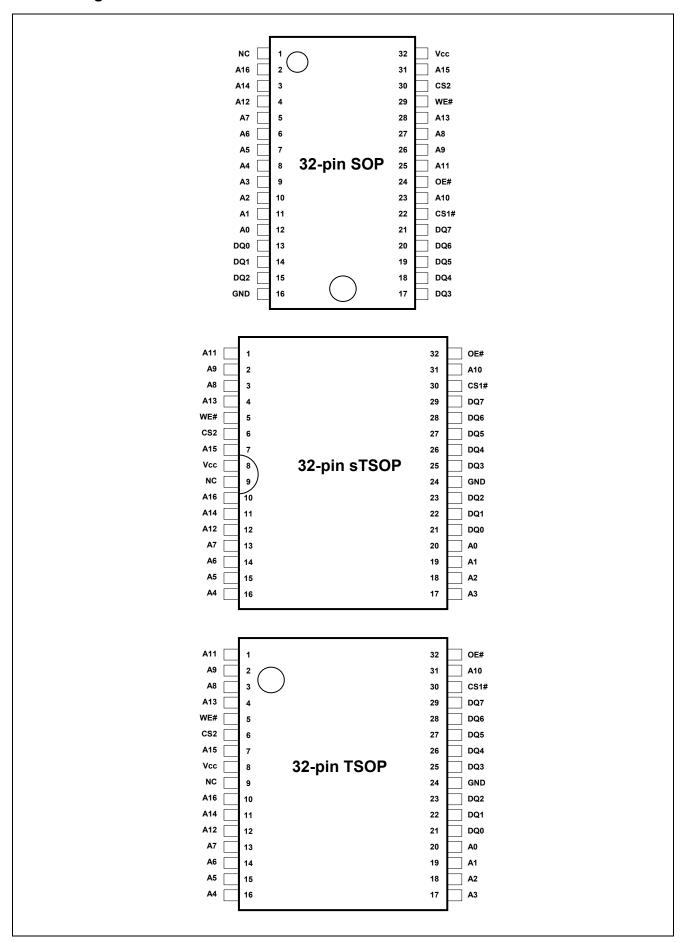
Features

- Single 2.7V~3.6V power supply
- Small stand-by current: 0.6µA (3.0V, typical)
- No clocks, No refresh
- All inputs and outputs are TTL compatible.
- Easy memory expansion by CS1# and CS2
- Common Data I/O
- Three-state outputs: OR-tie Capability
- OE# prevents data contention on the I/O bus

Ordering Information

Orderable part name	Access time	Temperature range	Package	Shipping container
R1LV0108ESN-5SI#B0			525-mil 32-pin	Tube (Magazine)
R1LV0108ESN-5SI#S0			plastic SOP	Embossed tape
R1LV0108ESA-5SI#B1	55 ns	-40 ~ +85°C	8mm×13.4mm 32-pin	Tray
R1LV0108ESA-5SI#S1	55 118	-40 ~ +65 C	plastic sTSOP	Embossed tape
R1LV0108ESF-5SI#B1			8mm×20mm 32-pin	Tray
R1LV0108ESF-5SI#S1			plastic TSOP	Embossed tape

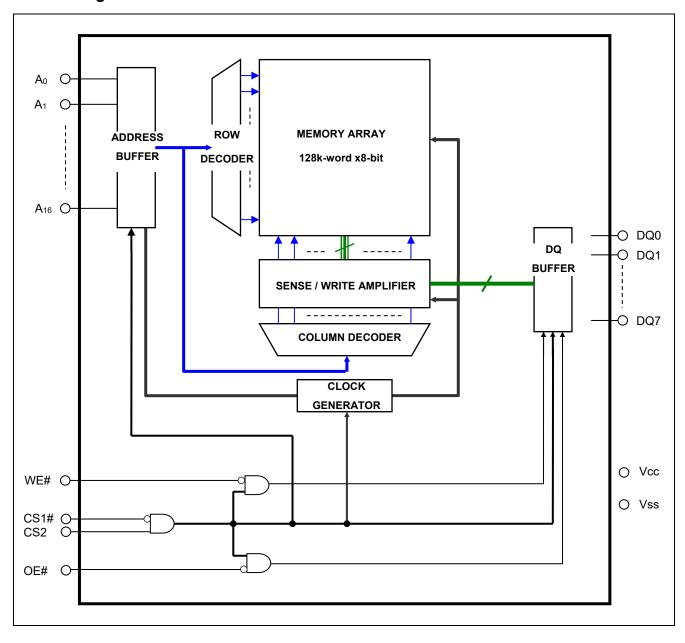
Pin Arrangement



Pin Description

Pin name	Function	
Vcc	Power supply	
Vss (GND)	Ground	
A0 to A16	Address input	
DQ0 to DQ7	Data input/output	
CS1#	Chip select 1	
CS2	Chip select 2	
WE#	Write enable	
OE#	Output enable	
NC	Non connection	

Block Diagram



Operation Table

CS1#	CS2	WE#	OE#	DQ0~7	Operation
Х	L	Х	Х	High-Z	Stand-by
Н	Х	Х	Х	High-Z	Stand-by
L	Н	L	Χ	Din	Write
L	Н	Н	L	Dout	Read
L	Н	Н	Н	High-Z	Output disable

Note 1. H: V_{IH} L:V_{IL} X: V_{IH} or V_{IL}

Absolute Maximum

Parameter	Symbol	Value	unit
Power supply voltage relative to Vss	Vcc	-0.3 to +4.6	V
Terminal voltage on any pin relative to Vss	V _T	-0.3*1 to Vcc+0.3*2	V
Power dissipation	P _T	0.7	W
Operation temperature	Topr	-40 to +85	°C
Storage temperature range	Tstg	-65 to 150	°C
Storage temperature range under bias	Tbias	-40 to +85	°C

Note 1. –3.0V for pulse ≤ 30ns (full width at half maximum)

2. Maximum voltage is +4.6V.

DC Operating Conditions

Parameter	Symbol	Min.	Тур.	Max.	Unit	Note
Supply voltage	Vcc	2.7	3.0	3.6	V	
	Vss	0	0	0	V	
Input high voltage	V _{IH}	2.0	-	Vcc+0.3	V	
Input low voltage	VIL	-0.3	-	0.6	V	1
Ambient temperature range	Та	-40	-	+85	°C	

Note 1. -3.0V for pulse ≤ 30 ns (full width at half maximum)

DC Characteristics

Parameter	Symbol	Min.	Тур.	Max.	Unit		Test conditions	
Input leakage current		-	-	1	μА	Vin = Vss to Vcc		
Output leakage current	I _{LO}	-	-	1	μА	CS1# =V _{IH} OE# =V _{IH} , VI/O =Vss t	or CS2 =V _{IL} or to Vcc	
Average operating current	I _{CC1}	-	15	25	mA		duty =100%, II/O = 0mA, CS2 =V _{IH} , Others = V _{IH} /V _{IL}	
	I _{CC2}	-	2	5	mA	CS1# ≤ 0.2	s, duty =100%, II/O = 0mA, 2V, CS2 ≥ Vcc-0.2V, 1.2V, V _{IL} ≤ 0.2V	
Standby current	IsB	-	-	0.33	mA	"CS2 =V _{IL} " or "CS2 = V _{IH} and CS1# =V _{IH} ", Others = Vss to Vcc		
Standby current		-	0.6 ^{*1}	2	μА	~+25°C	Vin = Vss to Vcc,	
	I	-	-	3	μА	~+40°C	(1) CS2 ≤ 0.2V or	
	I _{SB1}	-	-	8	μА	~+70°C	(2) CS1# ≥ Vcc-0.2V, CS2 ≥ Vcc-0.2V	
		-	-	10	μА	~+85°C		
Output high voltage	V _{OH}	2.4	-	-	V	I _{OH} = -0.5m	ıA	
	V _{OH2}	Vcc - 0.5	-		V	I _{OH} = -0.05	mA	
Output low voltage	VoL	-	-	0.4	V	I _{OL} = 2mA		

Note 1. Typical parameter indicates the value for the center of distribution at 3.0V (Ta= 25°C), and not 100% tested.

Capacitance

 $(Vcc = 2.7V \sim 3.6V, f = 1MHz, Ta = -40 \sim +85^{\circ}C)$

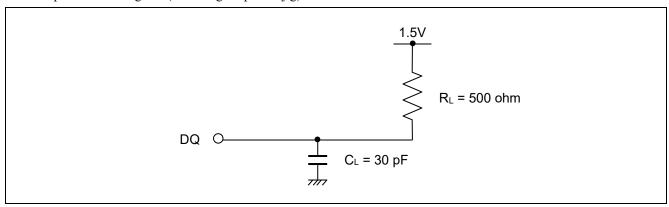
Parameter	Symbol	Min.	Тур.	Max.	Unit	Test conditions	Note
Input capacitance	C in	-	-	8	pF	Vin =0V	1
Input / output capacitance	C 1/0	-	-	10	pF	VI/O =0V	1

Note 1. This parameter is sampled and not 100% tested.

AC Characteristics

Test Conditions (Vcc = $2.7V \sim 3.6V$, Ta = $-40 \sim +85$ °C)

- Input pulse levels: VIL = 0.4V, VIH = 2.2V
- Input rise and fall time: 5ns
- Input and output timing reference level: 1.5V
- Output load: See figures (Including scope and jig)



Read Cycle

Parameter	Symbol	Min.	Max.	Unit	Note
Read cycle time	t _{RC}	55	-	ns	
Address access time	t _{AA}	-	55	ns	
Chin palest appear time	t _{ACS1}	-	55	ns	
Chip select access time	t _{ACS2}	-	55	ns	
Output enable to output valid	toE	-	30	ns	
Output hold from address change	tон	5	-	ns	
Chin coloct to cutnut in law 7	t _{CLZ1}	5	-	ns	2,3
Chip select to output in low-Z	t _{CLZ2}	5	-	ns	2,3
Output enable to output in low-Z	toLZ	5	-	ns	2,3
Chin decelert to output in high 7	t _{CHZ1}	0	20	ns	1,2,3
Chip deselect to output in high-Z	t _{CHZ2}	0	20	ns	1,2,3
Output disable to output in high-Z	tonz	0	20	ns	1,2,3

Write Cycle

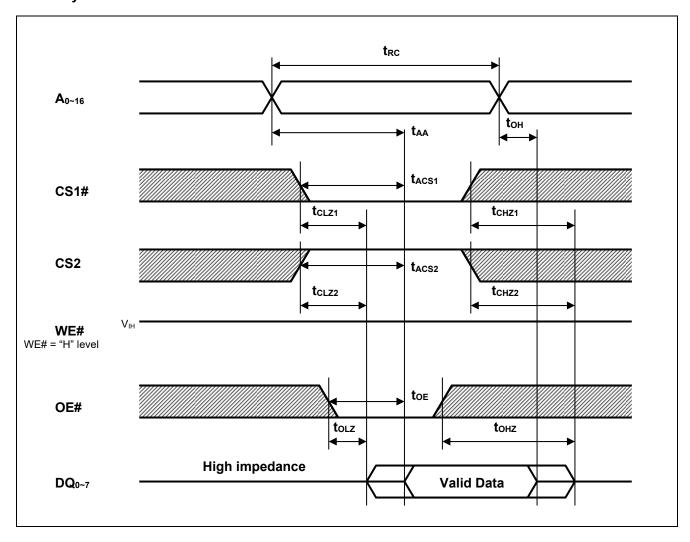
Parameter	Symbol	Min.	Max.	Unit	Note
Write cycle time	twc	55	-	ns	
Address valid to end of write	t _{AW}	50	-	ns	
Chip select to end of write	tcw	50	-	ns	5
Write pulse width	twp	45	-	ns	4
Address setup time	t _{AS}	0	-	ns	6
Write recovery time	twR	0	-	ns	7
Data to write time overlap	t _{DW}	25	-	ns	
Data hold from write time	t₀н	0	-	ns	
Output enable from end of write	tow	5	-	ns	2
Output disable to output in high-Z	tonz	0	20	ns	1,2
Write to output in high-Z	t _{whz}	0	20	ns	1,2

Note

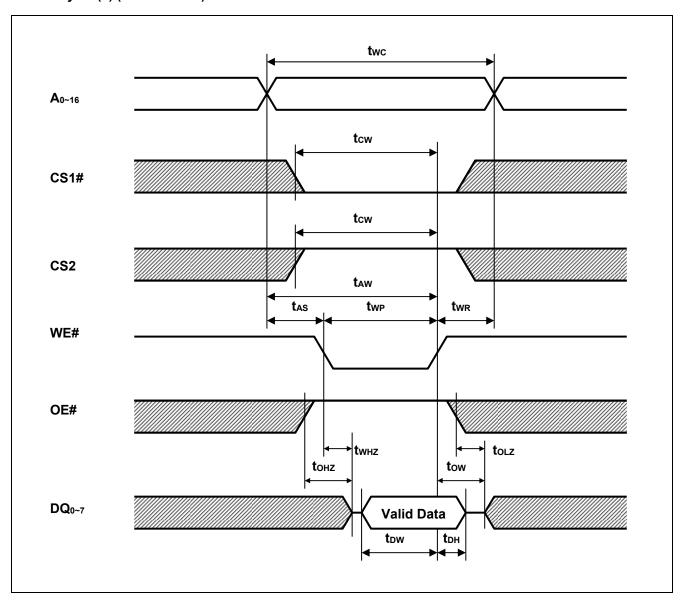
- 1. t_{CHZ}, t_{OHZ} and t_{WHZ} are defined as the time at which the outputs achieve the open circuit conditions and are not referred to output voltage levels.
- 2. This parameter is sampled and not 100% tested.
- 3. At any given temperature and voltage condition, t_{HZ} max is less than t_{LZ} min both for a given device and from device to device.
- 4. A write occurs during the overlap of a low CS1#, a high CS2, a low WE#.
 - A write begins at the latest transition among CS1# going low, CS2 going high and WE# going low.
 - A write ends at the earliest transition among CS1# going high, CS2 going low and WE# going high. t_{WP} is measured from the beginning of write to the end of write.
- 5. t_{CW} is measured from the later of CS1# going low or CS2 going high to end of write.
- 6. tas is measured the address valid to the beginning of write.
- 7. twR is measured from the earliest of CS1# or WE# going high or CS2 going low to the end of write cycle.
- 8. Don't apply inverted phase signal externally when DQ pin is output mode.

Timing Waveforms

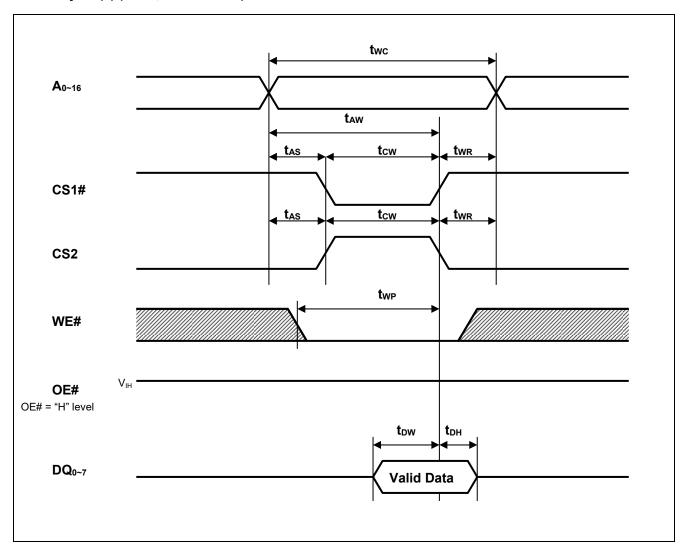
Read Cycle



Write Cycle (1) (WE# CLOCK)



Write Cycle (2) (CS1#, CS2 CLOCK)



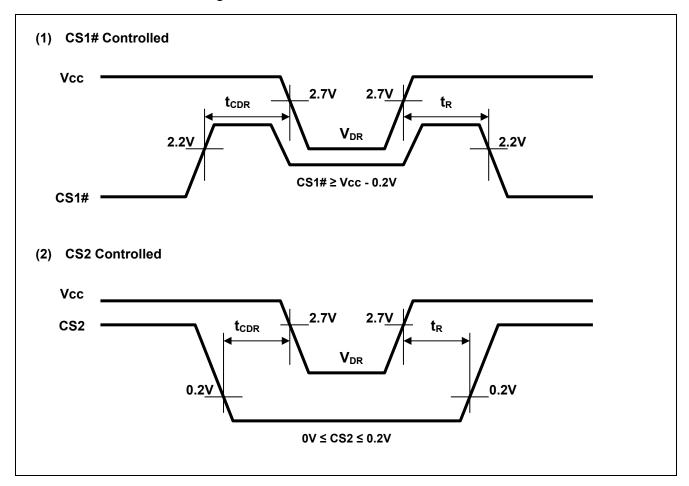
Low Vcc Data Retention Characteristics

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test conditions*2		
V _{CC} for data retention	V _{DR}	2.0	-	3.6	>	Vin ≥ 0V, (1) 0V ≤ CS2 ≤ 0.2V or (2) CS1# ≥ Vcc-0.2V, CS2 ≥ Vcc-0.2V		
	Iccdr	-	0.6*1	2	μΑ	~+25°C	Vcc=3.0V, Vin ≥ 0V,	
Data retention current		-	-	3	μΑ	~+40°C	(1) 0V ≤ CS2 ≤ 0.2V or	
Data retention current		-	ı	8	μΑ	~+70°C	(2) CS1# ≥ Vcc-0.2V, CS2 ≥ Vcc-0.2V	
		-	-	10	μΑ	~+85°C		
Chip deselect time to data retention	tcdr	0	_	-	ns	Con motoration was reformed		
Operation recovery time	t _R	5	-	-	ms	See retention waveform.		

Note 1. Typical parameter indicates the value for the center of distribution at 3.0V (Ta= 25°C), and not 100% tested.

CS2 controls address buffer, WE# buffer, CS1# buffer, OE# buffer and Din buffer. If CS2 controls data retention mode, Vin levels (address, WE#, CS1#, OE#, DQ) can be in the high impedance state.
 If CS1# controls data retention mode, CS2 must be CS2 ≥ Vcc-0.2V or 0V ≤ CS2 ≤ 0.2V. The other input levels (address, WE#, OE#, DQ) can be in the high impedance state.

Low Vcc Data Retention Timing Waveforms



Revision History	R1LV0108E Series Data Sheet
------------------	-----------------------------

				Description			
Re	V.	Date	Page	Summary			
1.0	00	2017.1.27	-	First Edition issued			

Notice

- 1. Descriptions of circuits, software and other related information in this document are provided only to illustrate the operation of semiconductor products and application examples. You are fully responsible for the incorporation or any other use of the circuits, software, and information in the design of your product or system. Renesas Electronics disclaims any and all liability for any losses and damages incurred by you or third parties arising from the use of these circuits, software, or information
- 2. Renesas Electronics hereby expressly disclaims any warranties against and liability for infringement or any other disputes involving patents, copyrights, or other intellectual property rights of third parties, by or arising from the use of Renesas Electronics products or technical information described in this document, including but not limited to, the product data, drawing, chart, program, algorithm, application
- 3. No license, express, implied or otherwise, is granted hereby under any patents, copyrights or other intellectual property rights of Renesas Electronics or others.
- 4. You shall not alter, modify, copy, or otherwise misappropriate any Renesas Electronics product, whether in whole or in part. Renesas Electronics disclaims any and all liability for any losses or damages incurred by you or third parties arising from such alteration, modification, copy or otherwise misappropriation of Renesas Electronics products.
- 5. Renesas Electronics products are classified according to the following two quality grades: "Standard" and "High Quality". The intended applications for each Renesas Electronics product depends on the product's quality grade, as indicated below
 - "Standard": Computers; office equipment; communications equipment; test and measurement equipment; audio and visual equipment; home electronic appliances; machine tools; personal electronic equipment; and industrial robots etc.

"High Quality": Transportation equipment (automobiles, trains, ships, etc.); traffic control (traffic lights); large-scale communication equipment; key financial terminal systems; safety control equipment; etc Renesas Electronics products are neither intended nor authorized for use in products or systems that may pose a direct threat to human life or bodily injury (artificial life support devices or systems, surgical implantations etc.), or may cause serious property damages (space and undersea repeaters; nuclear power control systems; aircraft control systems; key plant systems; military equipment; etc.). Renesas Electronics disclaims any and all liability for any damages or losses incurred by you or third parties arising from the use of any Renesas Electronics product for which the product is not intended by Renesas

- 6. When using the Renesas Electronics products, refer to the latest product information (data sheets, user's manuals, application notes, "General Notes for Handling and Using Semiconductor Devices" in the reliability handbook, etc.), and ensure that usage conditions are within the ranges specified by Renesas Electronics with respect to maximum ratings, operating power supply voltage range, heat radiation characteristics, installation, etc. Renesas Electronics disclaims any and all liability for any malfunctions or failure or accident arising out of the use of Renesas Electronics products beyond such specified
- 7. Although Renesas Electronics endeavors to improve the quality and reliability of Renesas Electronics products, semiconductor products have specific characteristics such as the occurrence of failure at a certain rate and malfunctions under certain use conditions. Further, Renesas Electronics products are not subject to radiation resistance design. Please ensure to implement safety measures to guard them against the possibility of bodily injury, injury or damage caused by fire, and social damage in the event of failure or malfunction of Renesas Electronics products, such as safety design for hardware and software including but not limited to redundancy, fire control and malfunction prevention, appropriate treatment for aging degradation or any other appropriate measures by your own responsibility as warranty for your products/system. Because the evaluation of microcomputer software alone is very difficult and not practical, please evaluate the safety of the final products or systems manufactured by you.
- 8. Please contact a Renesas Electronics sales office for details as to environmental matters such as the environmental compatibility of each Renesas Electronics product. Please investigate applicable laws and regulations that regulate the inclusion or use of controlled substances, including without limitation, the EU RoHS Directive carefully and sufficiently and use Renesas Electronics products in compliance with all these applicable laws and regulations. Renesas Electronics disclaims any and all liability for damages or losses occurring as a result of your noncompliance with applicable laws and regulations
- 9. Renesas Electronics products and technologies shall not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any applicable domestic or foreign laws or regulations. You shall not use Renesas Electronics products or technologies for (1) any purpose relating to the development, design, manufacture, use, stockpiling, etc., of weapons of mass destruction, such as nuclear weapons, chemical weapons, or biological weapons, or missiles (including unmanned aerial vehicles (UAVs)) for delivering such weapons, (2) any purpose relating to the development, design, manufacture, or use of conventional weapons, or (3) any other purpose of disturbing international peace and security, and you shall not sell, export, lease, transfer, or release Renesas Electronics products or technologies to any third party whether directly or indirectly with knowledge or reason to know that the third party or any other party will engage in the activities described above. When exporting, selling, transferring, etc., Renesas Electronics products or technologies, you shall comply with any applicable export control laws and regulations promulgated and administered by the governments of the
- 10. Please acknowledge and agree that you shall bear all the losses and damages which are incurred from the misuse or violation of the terms and conditions described in this document, including this notice, and hold Renesas Electronics harmless, if such misuse or violation results from your resale or making Renesas Electronics products available any third party.
- 11. This document shall not be reprinted, reproduced or duplicated in any form, in whole or in part, without prior written consent of Renesas Electronics
- 12. Please contact a Renesas Electronics sales office if you have any questions regarding the information contained in this document or Renesas Electronics products.
- (Note 1) "Renesas Electronics" as used in this document means Renesas Electronics Corporation and also includes its majority-owned subsidiaries
- (Note 2) "Renesas Electronics product(s)" means any product developed or manufactured by or for Renesas Electronics.

(Rev.3.0-1 November 2016)



SALES OFFICES

Renesas Electronics Corporation

http://www.renesas.com

Refer to "http://www.renesas.com/" for the latest and detailed information

Renesas Electronics America Inc. 2801 Scott Boulevard Santa Clara, CA 95050-2549, U.S.A. Tel: +1-408-588-6000, Fax: +1-408-588-6130

Renesas Electronics Canada Limited 9251 Yonge Street, Suite 8309 Richmond Hill, Ontario Canada L4C 9T3 Tel: +1-905-237-2004

Renesas Electronics Europe Limited
Dukes Meadow, Millboard Road, Bourne End, Buckinghamshire, SL8 5FH, U.K
Tel: +44-1628-585-100, Fax: +44-1628-585-900

Renesas Electronics Europe GmbH

Arcadiastrasse 10, 40472 Düsseldorf, Germany Tel: +49-211-6503-0, Fax: +49-211-6503-1327

Renesas Electronics (China) Co., Ltd.
Room 1709, Quantum Plaza, No.27 ZhiChunLu Haidian District, Beijing 100191, P.R.China Tel: +86-10-8235-1155, Fax: +86-10-8235-7679

Renesas Electronics (Shanghai) Co., Ltd.

Unit 301, Tower A, Central Towers, 555 Langao Road, Putuo District, Shanghai, P. R. China 200333 Tel: +86-21-2226-0888, Fax: +86-21-2226-0999

Renesas Electronics Hong Kong Limited Unit 1601-1611, 16/F., Tower 2, Grand Century Place, 193 Prince Edward Road West, Mongkok, Kowloon, Hong Kong Tel: +852-2265-6688, Fax: +852 2886-9022

Renesas Electronics Taiwan Co., Ltd. 13F, No. 363, Fu Shing North Road, Taipei 10543, Taiwan Tel: +886-2-8175-9600, Fax: +886 2-8175-9670

Renesas Electronics Singapore Pte. Ltd. 80 Bendemeer Road, Unit #06-02 Hyflux Innovation Centre, Singapore 339949 Tel: +65-6213-0200, Fax: +65-6213-0300

Renesas Electronics Malaysia Sdn.Bhd. Unit 1207, Block B, Menara Amcorp, Amcorp Tel: +60-3-7955-9390, Fax: +60-3-7955-9510 p Trade Centre, No. 18, Jln Persiaran Barat, 46050 Petaling Jaya, Selangor Darul Ehsan, Malaysia

Renesas Electronics India Pvt. Ltd. No.777C, 100 Feet Road, HAL II Stage, Indiranagar, Bangalore, India Tel: +91-80-67208700, Fax: +91-80-67208777

Renesas Electronics Korea Co., Ltd. 12F., 234 Teheran-ro, Gangnam-Gu, Seoul, 135-080, Korea Tel: +82-2-558-3737, Fax: +82-2-558-5141